Notification Number:	20220804002.0	Notification Dat	e:	August 09, 2022	
Title: Datasheet for SN74HCS541					
Customer Contact: PC	l Manager		Dept:	Quality Services	
Change Type:		·			
Assembly Site	Design		☐ Wafer Bump Site		
Assembly Process	☐ Data Sh	_		fer Bump Material	
Assembly Materials		Part number change		fer Bump Process	
Mechanical Specificati		Test Site		fer Fab Site	
☐ Packing/Shipping/Labeling ☐ T		cess	_	fer Fab Materials	
Notice to Details			Wa	fer Fab Process	
Notification Details					
Description of Change: Texas Instruments Incorporated is announcing an information only notification.					
The product datasheet(s) is being updated as summarized below.					
The following change history provides further details.					
TEXAS INSTRUMENTS		001 0075	FA 00T00	SN74HCS541	
SOLOGION GOTOBER EST - NEVIGED MOGOT ESTE					
Changes from Revision * (O	<u> </u>			Page	
Updated the Example Layout for the SN74HCS541 in the RKS Package figure					
The datasheet number will be changing.					
Device Family	Ch	ange From:	Change To:		
SN74HCS541	SCLS875		SCLS875A		
These changes may be rev		et iinks provided.			
https://www.ti.com/product/SN74HCS541					
Error! Bookmark not defined.					
Reason for Change:					
To accurately reflect device characteristics.					
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):					
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.					
Changes to product identification resulting from this notification:					
None.					
Product Affected:					
SN74HCS541RKSR					
5.17 111055 1111(51)					

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail	
WW PCN Team	PCN www admin_team@list.ti.com	

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